



ECM-LX800

AMD Geode Processor LX800 3.5" Micro Module
with AMD CS5536 Chipset

- > Onboard AMD Geode LX800 BGA Processor
- > AMD CS5536 Chipset
- > One 200-pin SODIMM up to 1 GB DDR SDRAM
- > Dual View, 2-CH Audio
- > Dual Realtek RTL8101L LAN
- > ITE IT8888G PCI to ISA Bridge
- > 1 PC/104, 1 CF, 2 SATA, 4 COM, 4 USB, 16-bit GPIO
- > Fanless Operation

+ Spec

System	
Processor	AMD Geode LX800 1-Core 500MHz processor
System Chipset	AMD Geode LX800/CS5536
System Memory	1 x200-Pin DDR 333MHz SO-DIMM up to 1 GB or 1 x200-Pin DDR 400MHz SO-DIMM up to 1 GB
I/O Chip	Winbond W83627HG-AW
BIOS	Award 4Mbit Flash BIOS
Watchdog Timer	H/W Reset: 1sec.~255min. and 1sec. or 1min./step
H/W Status Monitor	Monitoring System Temperature and Voltage with Auto Throttling Control
Expansion	
Expansion	1 xPC/104
Storage	
Storage	1 xCompactFlash Type I/II Socket
I/O	
USB	4 x USB 2.0
SATA	2 xSATA II
COM Port	1 xRS-232/422/485 3 xRS-232 1 xLPT
DIO	1 x16bit GPIO
MIO	1 xPS2/ KB & MS 1 xEIDE 1 xIrDA
Display	
Chipset	AMD Geode LX800 Integrated Graphics Supports dual display
Resolution	VGA:Max. resolution 1920x1440@ 85Hz CRT + TTL Support 18/24 bit TFT Panel
Audio	
Chipset	Realtek ALC203 supports 2-CH
Audio Interface	Mic-in, Line-in, Line-out, CD audio-in
Ethernet	
Chipset	2 xRealtek 8101L
Ethernet Interface	1000 Base-Tx Gigabit Ethernet Compatible
LAN Port	2 x RJ-45
Mechanical & Environmental	
Power Requirement	+5 V @ 1.97 A, +12 V @ 0.10 A (with AMD Geode LX800 @ 0.9 W 500 MHz & 1 GB DDR333 SDRAM)
Power Type	AT/ATX
Operating Temp	0°C ~ 60°C (32°F ~ 140°F)
Storage Temp	-20°C ~ 80°C (-40°F ~ 176°F)
Operating Humidity	0% ~ 90% Relative Humidity, Non-condensing
Dimension (L x W)	5.7" x 4" (146mm x 101mm)
Weight	0.44lbs (0.2kg)
Certifications	



Certification Information	CE FCC Class A
Software Support	
OS Information	Win XP Win 2000 Win CE

 **Ordering**

ECM-LX800A-B2R
3.5" LX800 W/2SATA/6COM/CF B2

ECM-LX800A-B2BR
3.5" LX800 W/2SATA/6COM/CF Bulk B2